

Application Data Sheet

Application Information

Application number::	Not Yet Assigned
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	SEMICONDUCTOR COMPONENT AND METHOD FOR PRODUCING SAME
Attorney Docket Number::	543822002200
Request for Early Publication?::	No
Request for Non-Publication?::	No
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Germany
Status::	Full Capacity
Given Name::	Harry
Family Name::	HEDLER
City of Residence::	Germering
Country of Residence::	Germany
Street of mailing address::	Jahnstraße 8
City of mailing address::	Germering
Country of mailing address::	Germany
Postal or Zip Code of mailing address::	82110

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Germany
Status:: Full Capacity
Given Name:: Simon
Family Name:: MUFF
City of Residence:: Höhenkirchen
Country of Residence:: Germany
Street of mailing address:: Esterwagnerstraße 24
City of mailing address:: Höhenkirchen
Country of mailing address:: Germany
Postal or Zip Code of mailing address:: 85635

Correspondence Information

Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Germany	102 55 848.5	November 29, 2002	Yes

Assignee Information

Assignee name:: Infineon Technologies AG
Street of mailing address:: St.-Martin Strasse 53
City of mailing address:: München
Country of mailing address:: Germany
Postal or Zip Code of mailing address:: 81669